

A	2021-4-2	all	W01		

GBJ15005~GBJ1510

[illegible]

/ Descriptions

50~1000V 15A GBJ

56700"87009 7+ :":%9 :< " 2+9/9 %0=" %0 ">36+7< ,?(@)(((>=A3%.7%:"BC%% D+.)?#=5 ;E"\$72F7< !"

/ Features

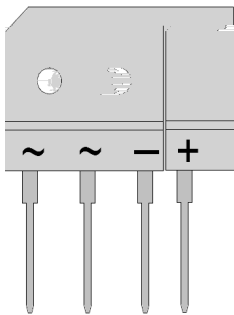
8B ; GH IJ>&(" H: 76"/3%"\$%9D+ : "2%2C9+"13: %:=B70 "4 7+ %976"4 36: : "\$670+92=K* "\$670+92"4 7+ %976"*70"G-H"/67 4 4 71969+L" 267009/927+93D" I J>& (= "M763< D"/% "\$3:C2+!" "

/ Applications

一般用途! "

/ Equivalent Circuit

/ Pinning



") " " " " " " " " N " " J "

80P) QB R " " " " 80P' #B" " 80P"N #B" " " " 80P"J QB&"

/ h_{FF} Classifications & Marking

S "T 7%F9D<"0D0+%C2+93D0

/ Absolute Maximum Ratings(Ta=25)

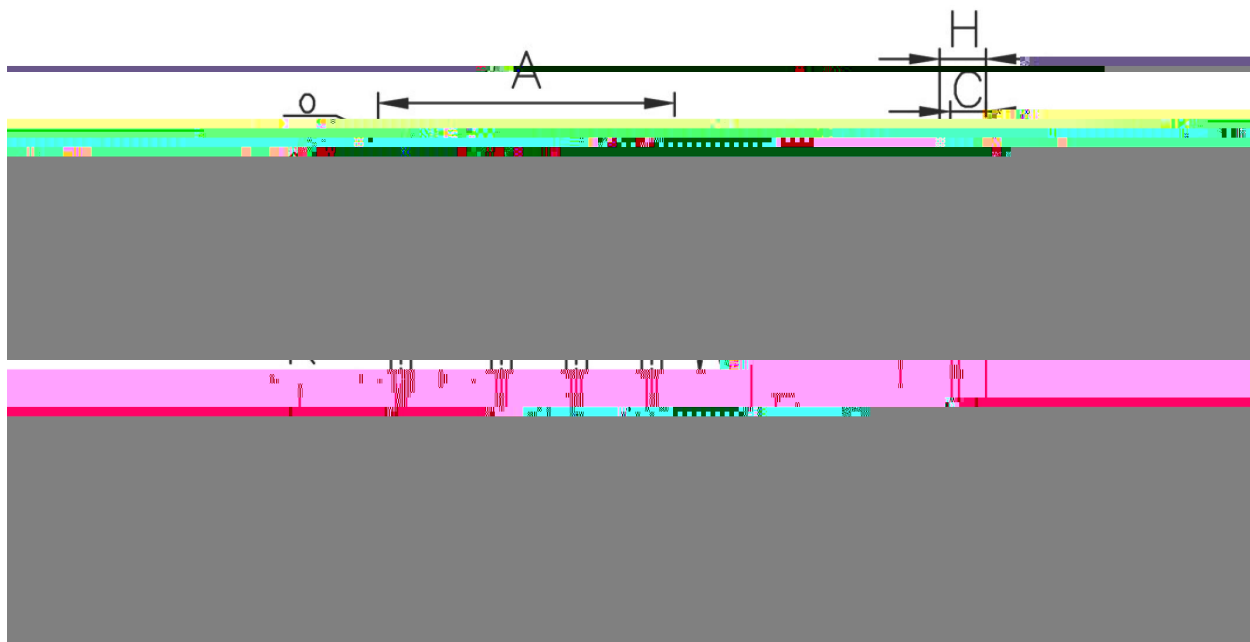
P_K\,""

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'! Q 92 "43CD+ : "3D")?(4 4b)?(4 4b)!U4 4"BC"867+ "M 7+09DF!"
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11

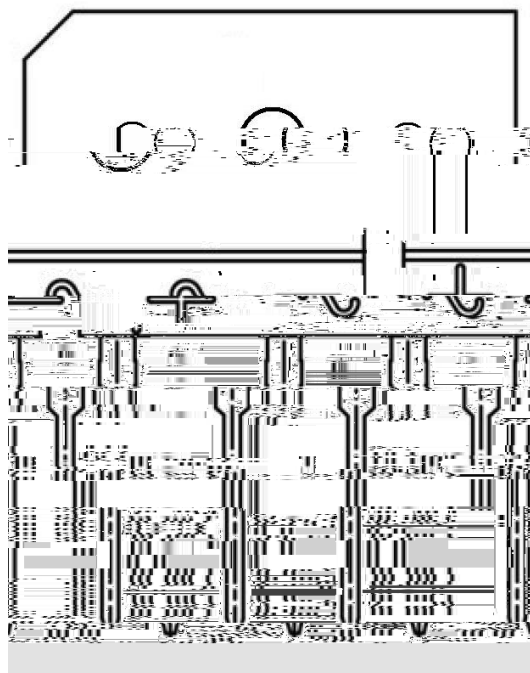
GBJ Package Outline Dimensions



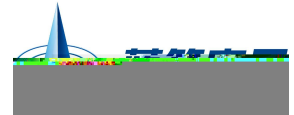
GBJ mechanical data



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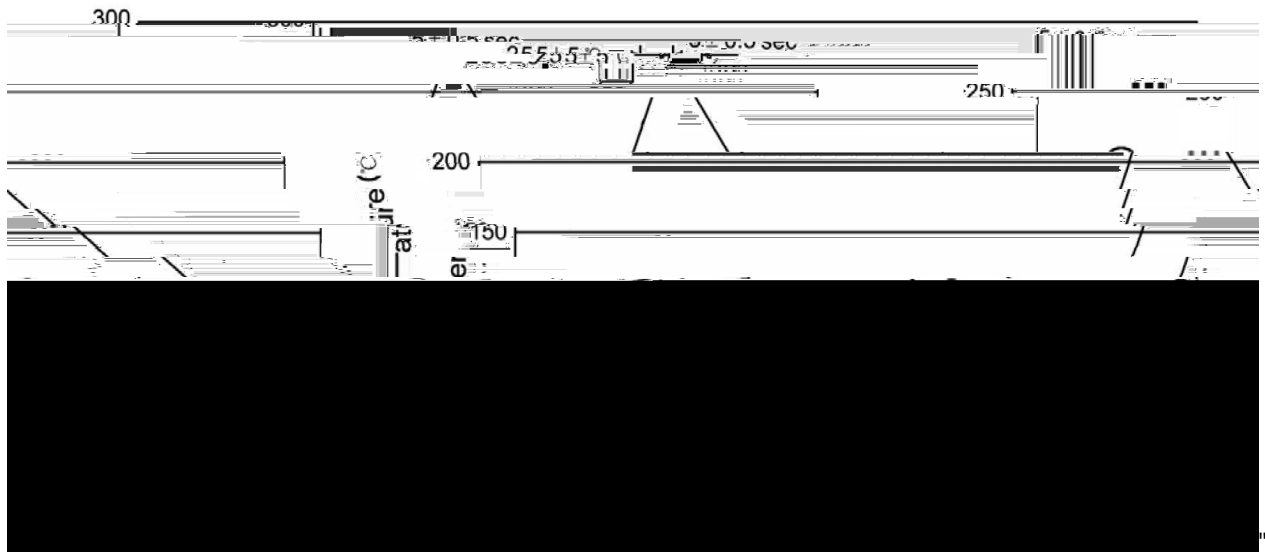


5 ;E)?((?," " 8%3:C2+"KL\$!" bbbb,,



"

() / Temperature Profile for Dip Soldering(Pb-Free)



" " " " " " " " " " " P3+ , "

) ' ?) ? (U (I (0 2e" " ") ! 8% * 7+9D<, ' ? @) ? (°C = " K 9 4 , U (@ I (0 2!"

' ' ?? ± ? ? ± (! ? 0 2e" " ' ! 8 7F"K 4 \$! , ' ?? ± ? °C = " Q C % 7 + 9 3 D , ? ± (! ? 0 2!"

N ') (°C - 0 2!" " " " N ! B 3 3 9 9 D < " S \$: , " ' @) (°C - 0 2!"

"

/ Resistance to Soldering Heat Test Conditions

"

' X (± ? °C " ") (±) " 0 2!" " " " K 4 \$! , ' X (f ? °C " " K 9 4 ,) (f) " 0 2"

"

• • / Packaging SPEC.

" " - " " ; GHg"

872F7< "KL\$ "	GD9+0 "	Q94 D093D" "	" " YCD9+ 4 4 "Z"
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